



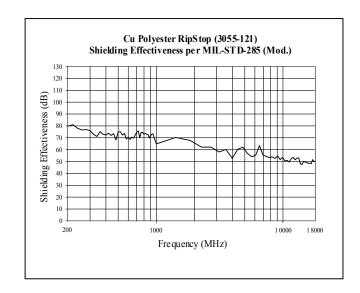
# **Copper Polyester Ripstop**

Flectron® Copper Polyester Ripstop is a unique fabric manufactured using a patented, proprietary technology. This technology combines a highly conductive metal with the lightweight, drapability and attractive appearance of a Polyester Ripstop. Copper Polyester Ripstop offers excellent surface conductivity and shielding effectiveness for a variety of applications.

#### **Physical Properties**

<u>Property</u> Substrate	<u>Units</u>	<u>Value</u> Polyester Ripstop	Advantage Flexible, Breathable
Metal		Cu	Highly Conductive
Basis Weight	oz./yd.² g/m.²	2.0-2.7 68-92	Light Weight
Thickness, (nominal) (ASTMD1777)	Inches microns	0.007 178	Thin and Drapable
Metal Weight	oz./yd.² g/m.²	0.40070 14-24	Excellent Electrical Properties
Max Short Duration Temperature		210°C	Allows Thermal Processing

## Product No.: 3055-121



#### **Electrical Properties**

<b>Property</b>	<u>Units</u>	<u>Value</u> fi
Surface Resistively (ASTM F390)	ohms/square	<u>&lt;</u> 0.01
Far-field Shielding	Effectiveness	(typical)
At 100 MHz At 1 GHz	dB dB	90 80

### **Mechanical Properties**

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Property	<u>Units</u>	<u>Value<sup>fi</sup></u>
Tensile Strength CMD/MD <sup>0</sup> (ASTM D5035)	lb./in N/100mm	60/65 1050/1138
Elongation, MD (ASTM D5035) Typical values for greige fabric.  Cross Machine Direction/Machine Direction		27%

FLECTRON® Copper Polyester Ripstop can be used in many different configurations to protect against EMI/RFI and ESD in a variety of applications. Typical applications include: enclosures, cables, gaskets, tapes, and grounding.

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